

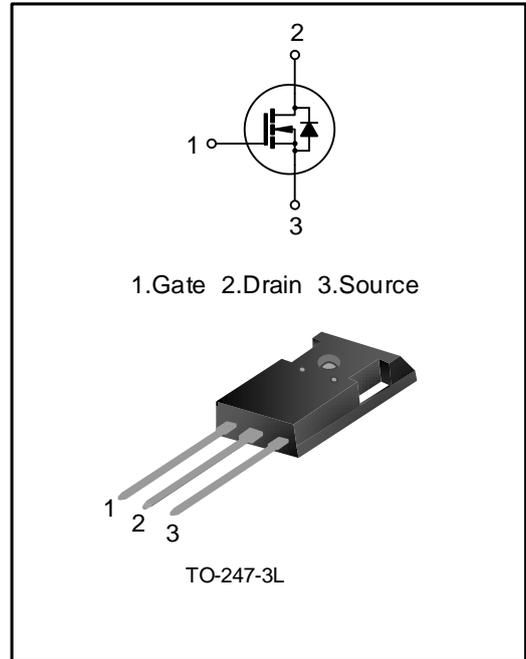
43A, 650V SUPER JUNCTION MOS POWER TRANSISTOR

DESCRIPTION

SVSP65R080P7HD4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior. Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.

FEATURES

- ◆ 43A, 650V, $R_{DS(on)(typ.)}=66m\Omega@V_{GS}=10V$
- ◆ New revolutionary high voltage technology
- ◆ Ultra low gate charge
- ◆ Periodic avalanche rated
- ◆ Extreme dv/dt rated
- ◆ High peak current capability
- ◆ 100% avalanche tested
- ◆ Pb-free lead plating
- ◆ RoHS compliant



KEY PERFORMANCE PARAMETERS

Characteristics	Ratings	Unit
V_{DS}	650	V
$V_{GS(th)}$	3.0~5.0	V
$R_{DS(on),max.}$	80	$m\Omega$
$I_{D,pulse}$	160	A
$Q_{g,typ.}$	95	nC

ORDERING INFORMATION

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVSP65R080P7HD4	TO-247-3L	P65R080P7	Halogen free	Tube

ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, T_J=25°C)

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Voltage	V _{DS}	--	--	--	650	V
Gate-source Voltage (Static)	V _{GS}	--	-20	--	20	V
Gate-source Voltage (Dynamic)	V _{GS}	AC(f>1 Hz)	-30	--	30	V
Drain Current	I _D	T _C =25°C	--	--	43	A
		T _C =100°C	--	--	27	A
Drain Current Pulsed (Note 1)	I _{DM}	T _C =25°C	--	--	160	A
Power Dissipation (Note 2)	P _D	T _C =25°C	--	--	338	W
Single Pulsed Avalanche Energy	E _{AS}	L=79mH, V _{DD} =100V, R _G =25Ω, starting temperature T _J =25°C	--	--	1238	mJ
Single Pulsed Current	I _{AS}	--	--	--	5.6	A
Reverse Diode dv/dt	dv/dt	V _{DS} =0~400V, I _{SD} ≤ I _S , T _J =25°C	--	--	50	V/ns
MOSFET dv/dt Ruggedness	dv/dt	V _{DS} =0~400V	--	--	50	V/ns
Operation Junction Temperature Range	T _J	--	-55	--	150	°C
Storage Temperature Range	T _{stg}	--	-55	--	150	°C
Continuous Diode Forward Current	I _S	T _C =25°C, integral reverse P-N junction diode in the MOSFET	--	--	43	A
Diode Pulse Current	I _{S,pulse}		--	--	160	A
Maximum Diode Commutation Speed	di/dt	V _{DS} =0~400V, I _{SD} ≤ I _S , T _J =25°C	--	--	900	A/μs

THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Thermal Resistance, Junction-case, Bottom	R _{θJC}	--	--	--	0.37	°C/W
Thermal Resistance, Junction-ambient	R _{θJA}	--	--	--	50	°C/W
Soldering Temperature (in line)	T _{sold}	15 ₀ ⁺² sec, 1time	--	--	260	°C

ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED, $T_J=25^{\circ}\text{C}$)

Static characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Drain-source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	650	--	--	V
Drain-source Leakage Current	I_{DSS}	$V_{DS}=650V, V_{GS}=0V, T_J=25^{\circ}\text{C}$	--	--	1.0	μA
		$V_{DS}=650V, V_{GS}=0V, T_J=125^{\circ}\text{C}$	--	12	--	
Gate-source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	--	--	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	3.0	--	5.0	V
Static Drain-source On State Resistance	$R_{DS(on)}$	$V_{GS}=10V, I_D=21.5A, T_J=25^{\circ}\text{C}$	--	66	80	m Ω
		$V_{GS}=10V, I_D=21.5A, T_J=150^{\circ}\text{C}$	--	153	--	
Gate Resistance	R_G	$f=1\text{MHz}$	--	1.5	--	Ω

Dynamic characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Input Capacitance	C_{iss}	$f=1\text{MHz}, V_{GS}=0V, V_{DS}=200V$	--	4100	--	pF
Output Capacitance	C_{oss}		--	106	--	
Reverse Transfer Capacitance	C_{rss}		--	6.1	--	
Turn-on Delay Time	$t_{d(on)}$	$V_{DD}=400V, V_{GS}=13V, R_G=1.8\Omega, I_D=26.3A$ (Notes 3, 4)	--	26	--	ns
Turn-on Rise Time	t_r		--	28	--	
Turn-off Delay Time	$t_{d(off)}$		--	73	--	
Turn-off Fall Time	t_f		--	23	--	
Total Gate Charge	Q_g	$V_{DD}=480V, V_{GS}=10V, I_D=26.3A$ (Notes 3, 4)	--	95	--	nC
Gate-source Charge	Q_{gs}		--	33	--	
Gate-drain Charge	Q_{gd}		--	41	--	
Gate-plateau Voltage	$V_{plateau}$		--	7.4	--	

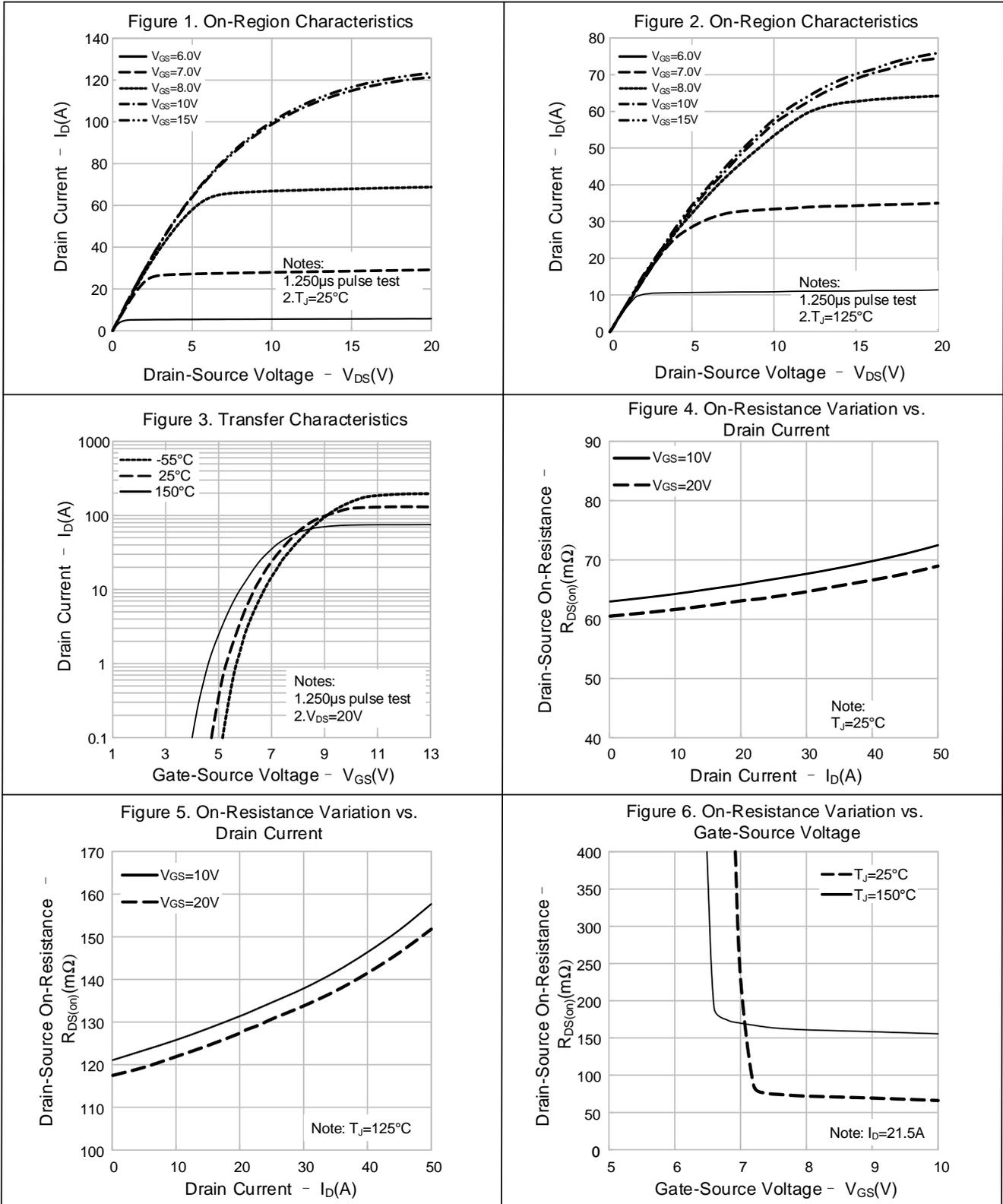
Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
			Min.	Typ.	Max.	
Diode Forward Voltage	V_{SD}	$I_S=26.3A, V_{GS}=0V$	--	--	1.4	V
Reverse Recovery Time	T_{rr}	$I_S=26.3A, V_{GS}=0V, V_R=400V, di/dt=100A/\mu s$ (Note 3)	--	125	--	ns
Reverse Recovery Charge	Q_{rr}		--	0.74	--	μC
Reverse Recovery Peak Current	I_{rrm}		--	11	--	A

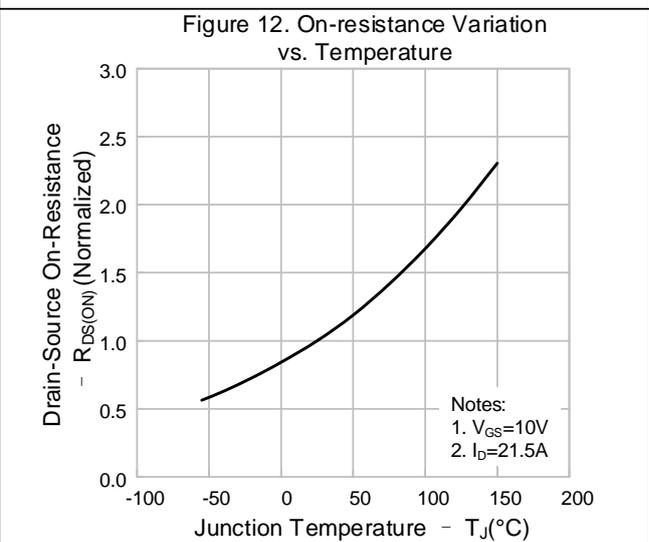
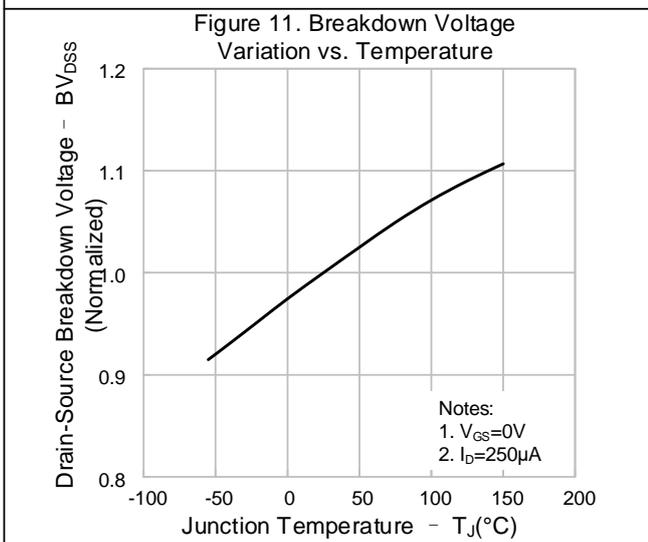
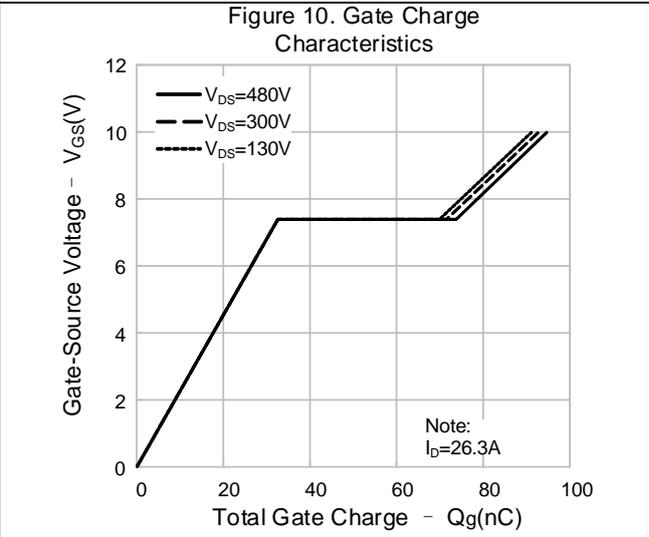
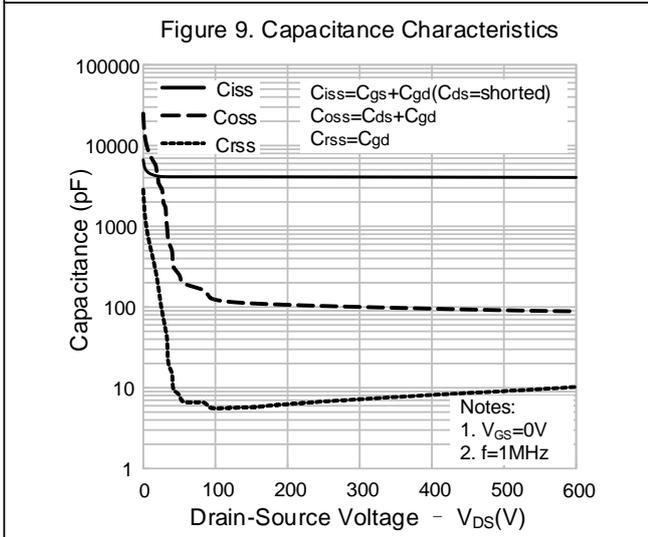
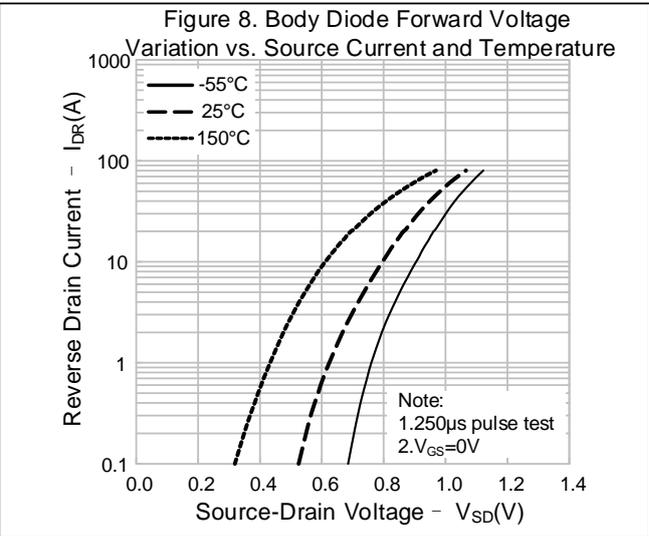
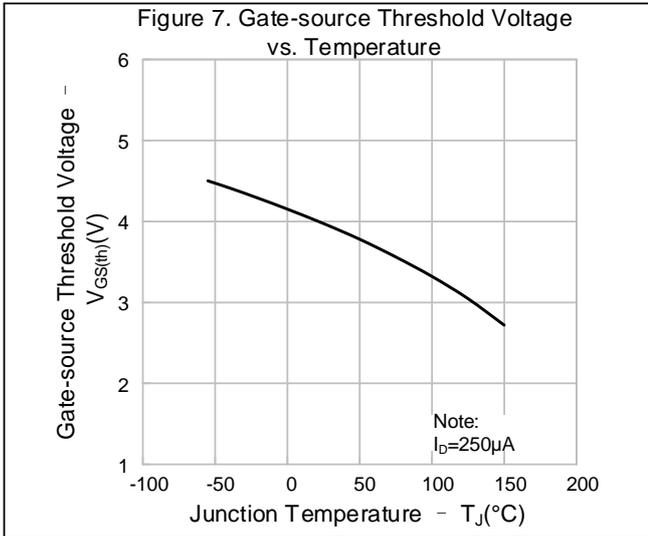
Notes:

- Pulse time $5\mu s$;
- The dissipation power will change with temperature, derating above 25°C : $2.7W/^{\circ}\text{C}$;
- Pulse Test: Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$;
- Essentially independent of operating temperature.

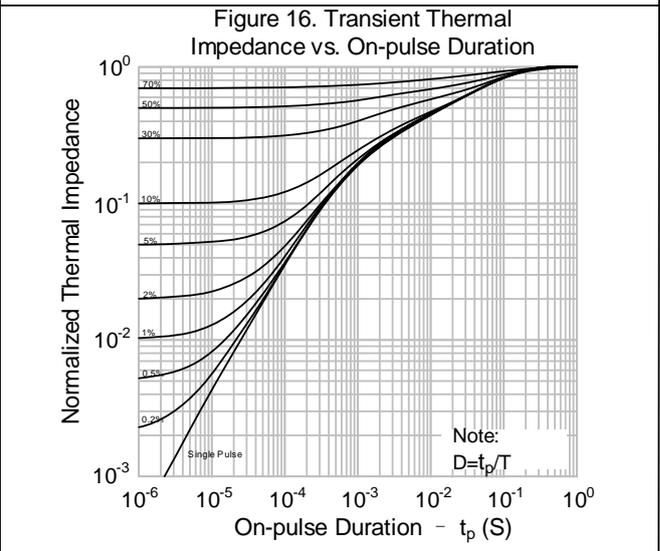
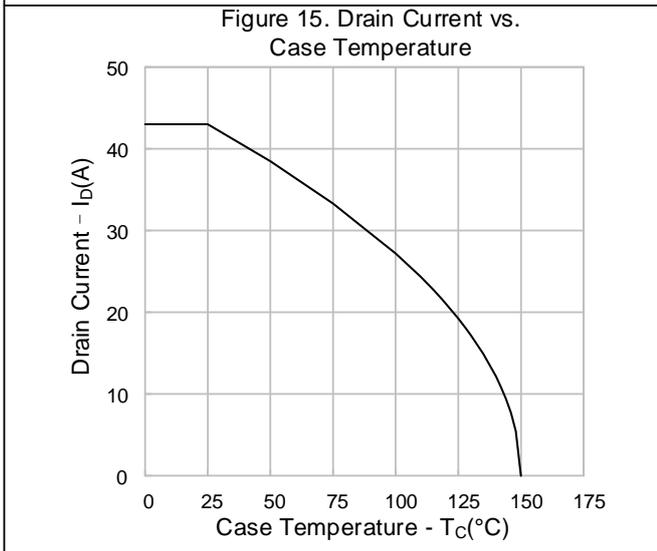
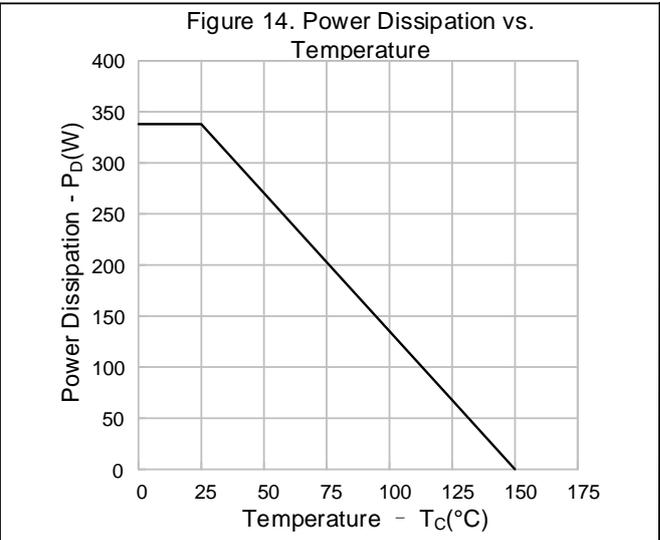
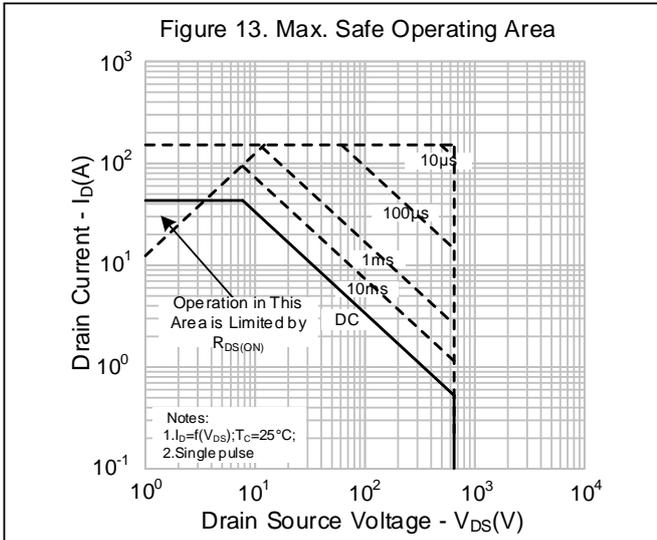
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (CONTINUED)

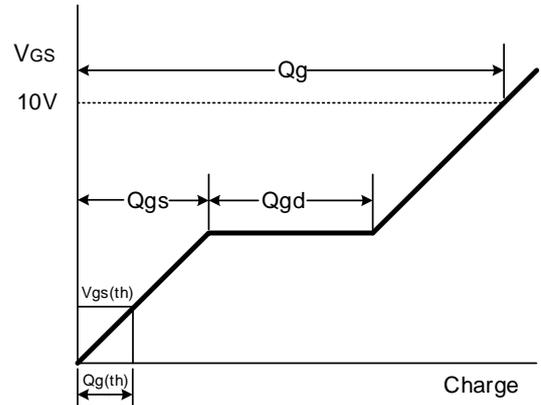
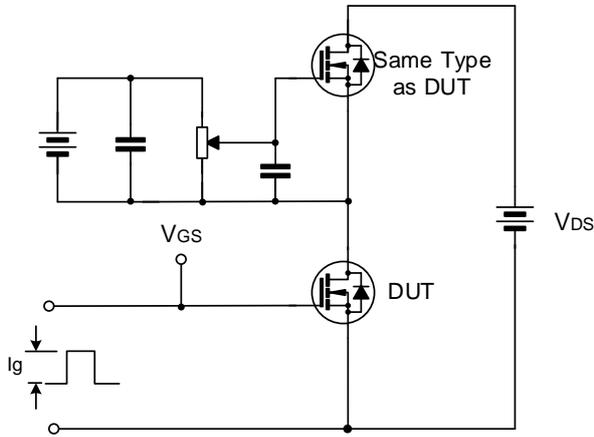


TYPICAL CHARACTERISTICS (CONTINUED)

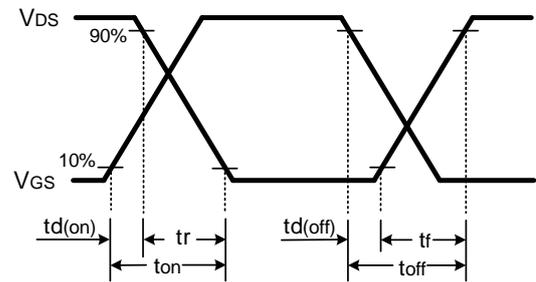
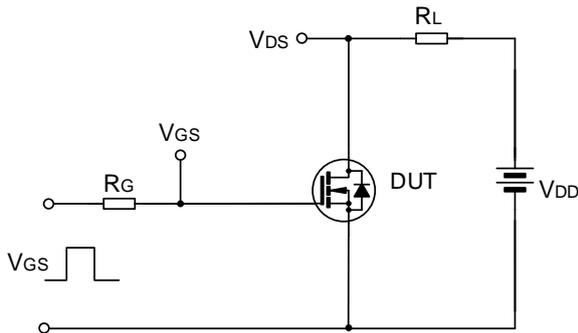


TYPICAL TEST CIRCUIT

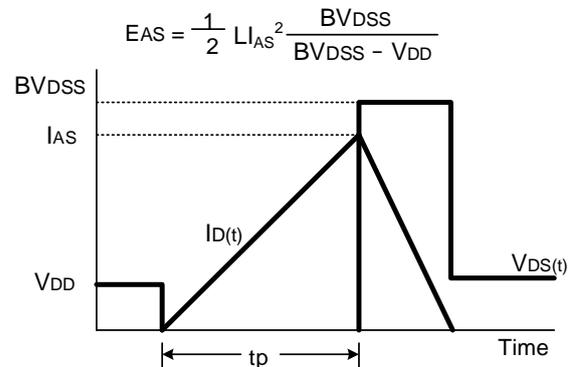
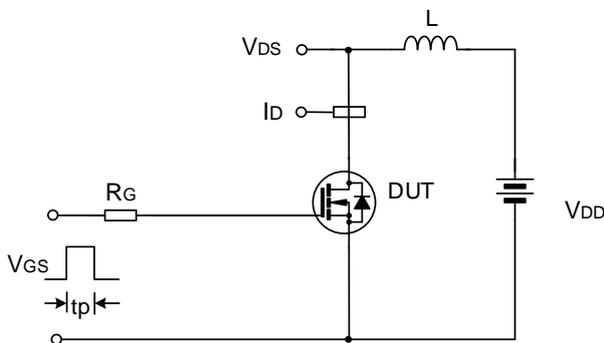
Gate Charge Test Circuit & Waveform



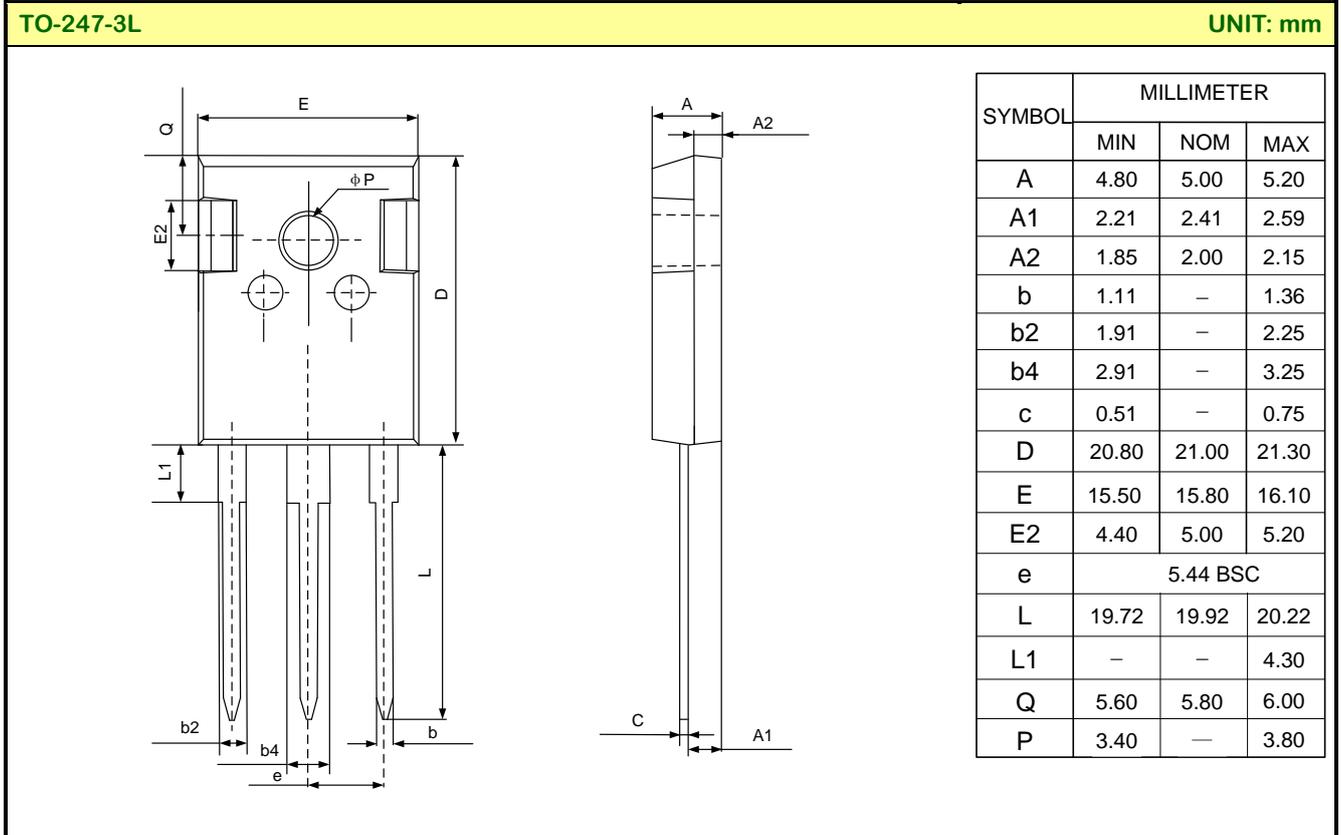
Resistive Switching Test Circuit & Waveform



Unclamped Inductive Switching Test Circuit & Waveform



PACKAGE OUTLINE



MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Important notice :

1. Silan reserves the right to make changes of this instruction without notice.
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Rev.: 1.0

Revision History:

1. First release
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